Analysis of EDM process and forecast the mean relative roughness (MRR) and the surface roughness of a material

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Abstract: Electrical-discharge machining (EDM) is a metal machining process that is generally considered as one of the most cutting-edge in the industry. It is also known as plasma cutting. It is a non-naturally occurring electric-thermal process in which metal is removed by the thermal energy emitted by a spark or other electric source. Tests were carried out on material removal rate and surface toughness, with a variety of factors, including time pulses, being used to determine the final findings. Rises in surface roughness and the formation of craters with wider and deeper features are seen as the pulse length increases. The MRR reduces when the pulse-off time is increased, whereas the surface ruggedness rises as a consequence of the increasing pulse-off time. In order to minimize any interruption to company activities, the substance was flushed away after work hours. It will be good to spend more time away from work throughout the flushing procedure. It can be seen in result that increasing the feed rates of wire from 6 to 8 kgf/cm2 leads in a modest increase in surface roughness, which increases from 3 1704 to 3 1738 microns in a very short period of time. Although only by a little amount, when the surface roughness rises from 8 to 10 kgf/cm2, the thickness of the film grows from 3,1738 to 3,1801 m, although in small increments. The major impacts of I/P variables such as pulse timings (wire, servo, and the MRR SR) and the output requirements for the MRR and SR have been addressed in this thesis. In addition, the interaction effects between the input/output requirements and the output stipulations have been examined. Specifically, the main objective of this paper is to forecast the mean relative roughness (MRR) and the surface roughness of a material. The job is carried out on the electro discharge machine of the sprint cut wire by changing the machining parameters and using a range of tools. In addition to the machine tool, the electric discharge wire cutting machine is equipped with an electrical supply as well as a dielectric supply unit for cutting wire. The bulk of activities are pre-programmed by the operator using an automated control system, which is installed at the facility.

Keywords: EDM process, Forecast the Mean Relative, Surface Roughness, MRR reduces, electric discharge wire cutting machine

I. INTRODUCTION

Machining methods are very important in today's manufacturing environment, when cost and grade are the most important considerations. Materials such as alloys, ceramics, and composites, which are designed for specific purposes, have very restricted machining capabilities. The creation of complex geometries in such materials is very challenging using conventional machining techniques. The traditional method of machining makes use of mechanical forces to remove materials that are in the way of the hard material's machining. Non-conventional machining techniques like as electrical, chemical, sound, and light are now being used in the manufacturing sector. These methods may process a hard component and convert it into a complex component. The machining techniques used are unusual in that they make use of some kind of energy rather than the traditional machining tools used in the industry. Unconventional machining may be used to solve issues such as high form and size complexity, as well as a higher need for accuracy and surface grade.

Types of EDM

Wire cut EDM (WEDM)

The EDM wire cut generates the necessary shape by using CNC movement to create the needed shape. There is no need for a certain shape of electrode. It makes use of a continuous vertical wire to produce the desired shape, which is controlled by a computer, and an electrode whose path is controlled by the computer. Electric heat sparks are used to cut the metal a dielectric fluid by a thin metal often made of brass. Wire EDM is often used for cutting plates as big as three hundred meters in length, as well as for creating tools, punches, and dies out of tough metals that are difficult to work with using traditional methods. The working gap is one of the most important elements in the removal of chips during EDM. Flushing these particles out of the circuit helps to prevent short circuit bridges from forming. Flushing is the process of introducing clean filtered dielectric fluid to the spark gap. It is possible that improper flushing will result in poor surface finishing and a low clearance rate. A high level of fluid pressure causes the chips to be removed prior to cutting, resulting in a slower removal of metal. If you apply too little pressure, the chips will not be removed as quickly as they should be, and erosion may be short-circuited.

Die-sinking EDM

It is necessary to attach a tool or an electrode to the ram that is connected to the positive terminal, and the work component to the negative terminal that is connected to the positive terminal. A dielectric fluid flow separates the tool from the workpiece, creating a very small space between the two. As soon as the power is turned on, the very high-frequency current impulses pass over the gap, resulting in the production of a spark. During the first few minutes of the process, metal erosion occurs as the tool is drawn further and deeper into the metal. The electrode's shape is a mirror copy of the metal cavity once it has been finished.

Process stipulations of EDM

- Time pulse (tone): the duration of time during which the current may flow per cycle is defined as follows: The amount of material removed is directly proportional to the amount of energy used during this time period. It is the time period during which the actual processing takes place.
- the refers to amount that discharge current is present between the sparks. It may be possible to remove the molten metal from the arc gap at this point since it has hardened. The speed and steadiness of the cutting are affected by these stipulations. The result is that unstable sparks are produced when the off time is too short.
- the discharge current (Ip) is defined as the current that increases until it reaches a preset level, which is denoted by the phrase "discharge current." The fact that the discharge current is higher indicates that the electrical discharge is stronger. It is a critical machining stipulation since the pace at which material is removed and the amount of power used are closely linked.
- The arc gap is defined as the distance between the electrode and the work piece. It is essential for maintaining performing proper servo responsible.
- Duty cycle (%): the rate of on-time is expressed as a percentage of the total length of the pulse. The spark energy is supplied during the longer pulse duration at a higher duty cycle, resulting in improved processing efficiency.
- the voltage of applied pulses influencing the energy of a spark is given in units of Voltage (V). During this process, the dielectric medium, which is dependent on the electrode spacing and dielectrically strength, is de-ionized, allowing current to pass.
- Dielectric fluid: This fluid serves as an electrical insulator, allowing the eroded particles to wash away with the water. The most often used dielectric liquids include deionized water, paraffin and kerosene, and light transformer oil, to name a few examples.
- Flushing the pond Pressure: flushing is a technique of delivering clean filtered dielectric fluid into the machining region by applying pressure to the fluid. Ineffective flushing may result in the formation of unwanted cavities that can cause harm to the workpiece. Flushing may be accomplished via a variety of ways, including injecting flushing, suction flushing, side flushing, motion flushing, and impulses. The usual pressure range is between 0.1 and 0.4 kgf/cm2, depending on the application.
- Lift Time: the amount of time it takes for an instrument to be raised and flushed through the ignition gap.

II. DESIGN OF EXPERIMENT (DOE)

DOE techniques enable designers to discover the individual and interaction effects of a large number of factors that may affect output outcomes in any design while working on the design at the same time. DOE provides a comprehensive picture of the interaction between design components. In the field of experimental design, the DOE is a time-saving planning method that allows for the evaluation of data in order to offer accurate and objective results. When designing an experiment, the first step is to determine the objectives of the experiment and the process variables that will be used in the experiment. creation complete prior to the performance of the experiment.

Methods of DOE

The Taguchi method is being used in this investigation. To get optimum control settings for an experiment, trials of "ORTHOGONAL ARRAY." This approach offers the experiment with optimal control stipulations s with much reduced "variance." "Orthogonal Arrays" () are tests that are provided by the OA. The represented by the are used in forecasting applications.

Steps to perform Taguchi design of experiment

A. functions that are critical, have cause.

- b. sources of, the under which the testing was conducted, and the characteristics of the product.
- c. Determine the best goal function to be used.
- d. Identify the variables and the degrees of control that are involved.
- d. Using the orthogonal array matrix, choose an experiment to perform.
- f. Carry out the experiments using the experimental matrix.

g. Data analysis; optimum levels and performance forecasts; and performance evaluation

Execute an experimental verification and make preparations for a follow-up.

There of factors:

(a) Model is one that level statuses. seller, kind material, and so forth.

(b) Continuous — The level factor may take on any functional value that is desired. For instance, temperature, pressure, span, and so on.

ANOVA ANALYSIS

When attempting to determine the proportion of each component in the results of an experiment, the most often used statistical technique is the analysis of variance (ANOVA). The ANOVA table research is useful in determining which variables should be watched and which ones should not. Typically, once an optimum condition has been identified, it is suggested that a confirmation experiment be conducted. When using fractional factorial testing, just a portion of the total number of factorial tests is performed. The study of the incomplete experiment must include a trust analysis that considers how much confidence. Consequently, the data is examined by technology; is determined by technology. The noise-controlled variables are provided by the analysis. Knowing the source of variation and the quantity of variation may help you predict how robust your operating conditions will be.

ANOVA Procedure

During the statistical analysis of variance, several variables such as degrees of freedom, square sums, mean squares, and other similar terms are computed and organized in a standard tabular format.

C.F. is an abbreviation for factor of correction. n is the number of tests performed.

r is the number of times something has happened. e is an abbreviation for error.

P denotes the contribution proportion. F denotes the variance to the mean ratio.

T represents the total number of outcomes. f is the degree of freedom.

S = Sum of fe squares = Grade of mistake freedom S = Sum of fe squares = Grade of error freedom

S = Sum of Squares fT = Total Freedom Level S = Sum of Squares fT = Total Freedom Level

V is the mean quadratic function (variance)

In each level, the equal to the. A. Total number trials

B. Degree of freedom: This refers to the amount of information that may be measured from a specific data set in a unique manner. The degree of freedom (DOF) for factor data.

In the case experimental data, from mean; it is also known as the sum of squares.

In the case of variance, the on is used to get the value of variance.

g. Variance ratio: Value F research to obtained traditional that has specific relevance for the study. It is not possible for a component to total in when lower in system.

ANOVA for Material Removal Rate

Endeavor, 27 experimental runs on a piece are carried out in accordance with the experiment design, which makes use of. For purpose experiment design, three used components.

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Sr. No.	Machining process stipulations	Level 1	Level 2	Level 3
1	$T_{on}(\mu s)$	110	115	120
2	$T_{off}(\mu s)$	40	45	50
3	F _p (kgf/cm2)	8	10	12
4	SV (volt)	15	20	25
5	W _f (m/min)	6	8	10

Table 1: Control stipulations

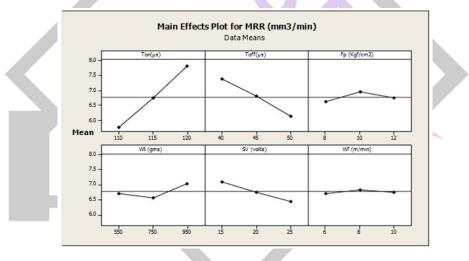
Total no of runs (n) = 27 Total degree of freedom (f) = n + 1

Total degree of freedom $(f_T) = n-1 = 26$

III. RESULT AND DISCUSSION

Any data obtained from the HCHCR wire cutting EDM after performing an experiment in each of the monitoring such as and will be provided.

Main Efficacious Plots for I/P stipulations s V/S Output stipulations



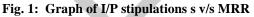


Figure 1 clearly demonstrates that the rate of material removal increases when the length of time between pulses is increased. When the time pulse is increased from 110 to 115 s, the removal rate of the material increases from 5,7585 to 6,7362mm3/min, indicating an increase in the rate of material removal. After a second increase in pulse duration from 115 to 120 s, the deletion rate increases from 6.7362 to 7.8102 mm3/min, representing a 12% increase.

Second graph in Figure 1 illustrates removed from the sample. The material removal rate decreases as the length of the pulse-off pulse rises, as shown in Fig. 1. When the is increased s, the of material indicating a decrease in efficiency. After to 50 s 45 50 s, removal rate of material decreases even more, falling shows flushing pressure at which materials are removed from the system. Figure 1 illustrates the removal rate of the material decreases from 6.6125 to 6.9501 mm3/min, as seen in the graph. If it increases any more, from 10 to 12 kgf/cm2, the clearance rate decreases from 6,9501 to 6,7423mm3/min, indicating a decrease in efficiency. Fig. 1 illustrates the relationship between wire tension and material removal rate in the fourth graph. As the as shown in Fig. 1. Now, if the wire voltage is increased further from 750 to 950 mm3/min, the deletion rate will increase from 6.5677 to 7.0304 mm3/min, a substantial increase in the rate of deletion. Figure 1 depicts the efficacious of servo voltage on the rate at which material is removed from the sample. It has been shown that the rate of material removal decreases gradually when the servo voltage is raised. When the servo voltage is increased the rate of. With a further increase in servo voltage for material even more, from 6,7471 to 6,4483 mm3/min, as seen in the graph. The sixth graph depicts the relationship between the wire feed rate and the rate of material removal. Figure 1 illustrates that the rate of the force per cm2 is increased from 6 to 8 kgf/cm2, as seen in the graph. When the rate

of elimination increases from 8 to 10 kgf/cm2, the amount of water that is eliminated reduces from 6,8384 to 6,7530mm3/min in minute amounts.

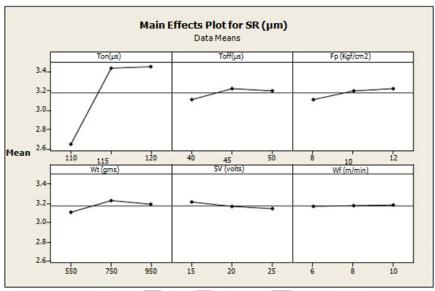


Fig. 2: Graph of I/P stipulations s v/s SR

Fig. 2 is a diagram of a tetrahedron. The first graphic depicts the efficacious of the pulse on the surface roughness as a function of time. In Fig.2, it can clearly be observed that surface roughness increases suddenly as the pulse lengthens over time. Surface roughness was improved by pulsing the surface at intervals of 110 to 115 s from 2,6457 to 3,4292 m. After a brief pause, the pulse was raised from 115 to 120 s, resulting in an increase in the roughness of the surface from 3,4292 to 3,4493 m.

The third graph depicts the efficacious of the surface roughness cleaning pressure on the surface roughness. According to Fig. 2, when the flushing pressure is increased the rawness. Surface roughness increases as well, increasing from 10 to 12kgf/cm2 and from 3,1952 to 3,2204 m, respectively.

The fourth graph in figure 2 depicts the relationship between wire tension and the roughness of the surface. According to Fig. 2, increasing the wire tension from 550 to 750 gms causes the surface roughness to increase surface ruggedness falls from 3.2267 to 3.1910 microns, indicating a reduction in surface toughness.

The efficacious of the servo voltage on the roughness of the surface is shown in Figure 2. It is shown that when the servo voltage is increased, the surface roughness decreases in a stepwise manner. Increase in the servo voltage from 15 to 20 volts causes a reduction in the roughness of the surface from 3,2131 to 3,1693 microns. As soon as the servo voltage is increased to between 20 and microns. The wire. Figure 2 demonstrates that increasing the feed rates of wire from 6 to 8 kgf/cm2 results in a small increase in surface roughness, which rises from 3,1704 to 3,1738 m in a short period of time. As the surface roughness increases from 8 to 10 kgf/cm2, the thickness of the film increases from 3,1738 to 3,1801 m, albeit only in minute amounts. It has been discussed in this chapter the main effects of I/P factors such as, pulse times, (wire, servo and the MRR SR) and the MRR and SR output stipulations s. In addition, the interaction effects between the I/P and output stipulations s have been investigated.

IV. CONCLUSION AND FUTURE SCOPE

For material removal rate and surface toughness, tests are carried out utilizing a variety of factors, including time pulses. After everything is said and done, it is possible to say that: a. The analysis employing ANOVA determines the percent contribution of the I/P stipulations to the output stipulations. According to the ANOVA results, the pulse contribution percentage on time was 63,49486 percent, the pulse contribution percentage off time was 23,7245 percent, the flush pressure was = 1,74876 percent, the cable voltage was 3,39776 percent, the servo voltage was 6,60981 percent, and the cable feed rate was = 0,245668 percent, indicating that the wire feed rate was significantly less influenced by the other stipulations. This means that the efficacious of wire feed rate is much smaller than the efficacious of the other factors. The percentage of wire tension = 1,42617 percent, the percentage of servo voltage = 0,67121 percent, and the percentage of pulse off time = 0,01312 percent According to the ANOVA results, the error for removal rate is 0.77863 percent and for surface ruggedness it is 1.29146 percent.

For the purpose of determining the optimal stipulations values, grey relational analysis is conducted. With the help of a gray relational analysis, it was determined that the best stipulations values were level 1, wire voltage (550 gms), level 1 servo voltage (15 volts), and level 1 wire feed rate (6 meters per minute). The optimal stipulations s discovered include an MRR of 5.6654 mm3/min and an SR of 2.2152 mm.

c. The importance of important stipulations and the percentage of their contribution change depending on the behavior of the stipulations with objective response.

d. As the amount of time in the power supply increases, the amount of spark-energy produced increases. Every answer was recognized by a time pulse, which determined the most significant feature. Surface roughness increases as the duration of the pulse grows, and as the duration of the pulse increases, craters with broader and deeper characteristics are formed.

e. The pulse off time results in an opposite efficacious to the pulse on time. The MRR reduces when the pulse-off time is extended, while the surface ruggedness increases. During non-business hours, the material was flushed away. More time away from work will help with the flushing.

f. Medium-pressure flushing is constantly looking for any kind of response.

g. Servo voltage has a minor influence on SR, but has a larger impact on MRR. As the servo voltage is increased, the surface roughness reduces.

h. Wire tension has a larger efficacious on MRR than on the roughness of the surface, although it has a smaller impact on the roughness of the surface. The preferred wire tension for all replies is also medium wire tension.

When dealing with EDM and WEDM processes, the mathematical model may be developed to accommodate a variety of working components and electrode materials.

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